



New Product

SUM110N02-03P
Vishay Siliconix

N-Channel 20-V (D-S) 175°C MOSFET

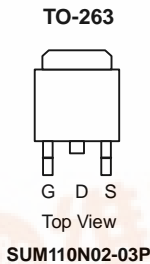
PRODUCT SUMMARY		
$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A) ^a
20	0.0032 @ $V_{GS} = 10$ V	110 ^a
	0.0052 @ $V_{GS} = 4.5$ V	110 ^a

FEATURES

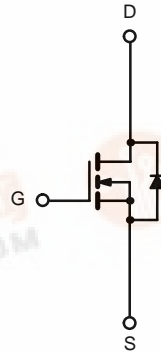
- TrenchFET® Power MOSFET
- 175°C Junction Temperature
- Optimized for Low-Side Synchronous Rectifier

APPLICATIONS

- Synchronous Buck DC/DC Conversion
 - Desktop
 - Server
- Load Switch



DRAIN connected to TAB



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)			
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	20	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 175^\circ\text{C}$)	I_D	$T_C = 25^\circ\text{C}$	110 ^a
		$T_C = 100^\circ\text{C}$	102
Pulsed Drain Current	I_{DM}	300	A
Maximum Power Dissipation ^b	P_D	$T_C = 25^\circ\text{C}$	120 ^c
		$T_A = 25^\circ\text{C}^d$	3.75
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 175	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Limit	Unit
Junction-to-Ambient (PCB Mount) ^d	R_{thJA}	40	$^\circ\text{C/W}$
Junction-to-Case	R_{thJC}	1.25	

Notes

- Package limited.
- Duty cycle $\leq 1\%$.
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).



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SPECIFICATIONS (T _J = 25 °C UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{DS} = 0 V, I _D = 250 μA	20			V
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.8		3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 16 V, V _{GS} = 0 V			1	μA
		V _{DS} = 16 V, V _{GS} = 0 V, T _J = 125 °C			50	
		V _{DS} = 16 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ 5 V, V _{GS} = 10 V	120			A
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A		0.0026	0.0032	Ω
		V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C			0.0048	
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.0055	
		V _{GS} = 4.5 V, I _D = 20 A		0.0042	0.052	
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 30 A	15			S
Dynamic^b						
Input Capacitance	C _{iSS}	V _{GS} = 0 V, V _{DS} = 10 V, f = 1 MHz		5100		pF
Output Capacitance	C _{oSS}			1650		
Reverse Transfer Capacitance	C _{rSS}			750		
Total Gate Charge ^b	Q _g	V _{DS} = 10V, V _{GS} = 4.5 V, I _D = 110 A		40	60	nC
Gate-Source Charge ^b	Q _{gs}			14		
Gate-Drain Charge ^b	Q _{gd}			13		
Gate Resistance	R _G			0.85		Ω
Turn-On Delay Time ^b	t _{d(on)}	V _{DD} = 10 V, R _L = 0.2 Ω I _D ≅ 110 A, V _{GEN} = 10 V, R _G = 2.5 Ω		15	25	ns
Rise Time ^b	t _r			11	20	
Turn-Off Delay Time ^b	t _{d(off)}			45	70	
Fall Time ^b	t _f			10	15	
Source-Drain Diode Ratings and Characteristics (T_C = 25 °C)^c						
Continuous Current	I _S				110	A
Pulsed Current	I _{SM}				300	
Forward Voltage ^a	V _{SD}	I _F = 110 A, V _{GS} = 0 V		1.1	1.5	V
Reverse Recovery Time	t _{rr}	I _F = 50 A, di/dt = 100 A/μs		45	70	ns
Peak Reverse Recovery Current	I _{RM}			1.8	2.7	A
Reverse Recovery Charge	Q _{rr}			0.041	0.095	μC

Notes

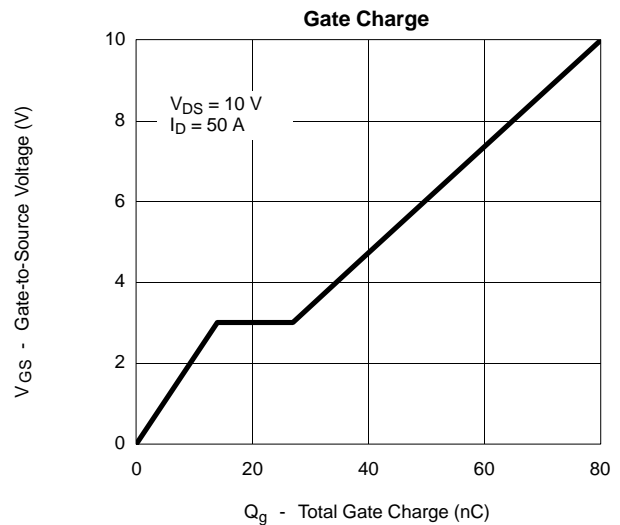
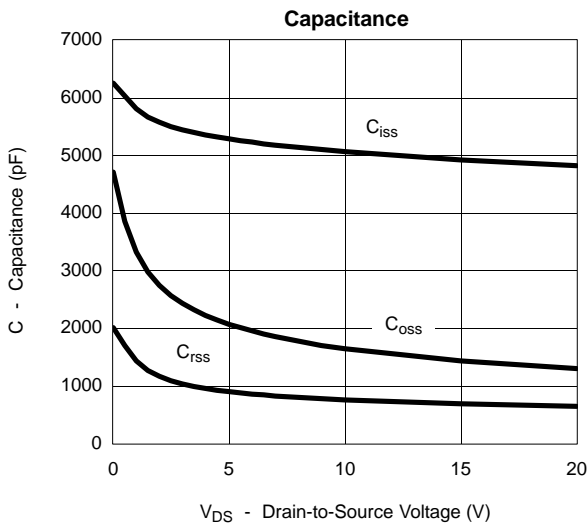
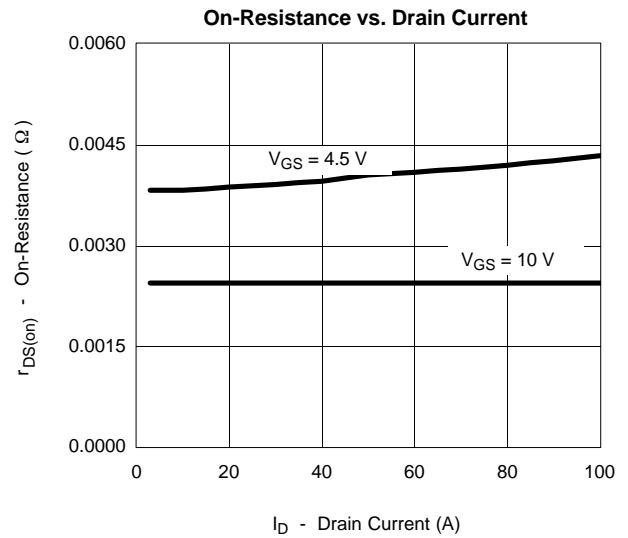
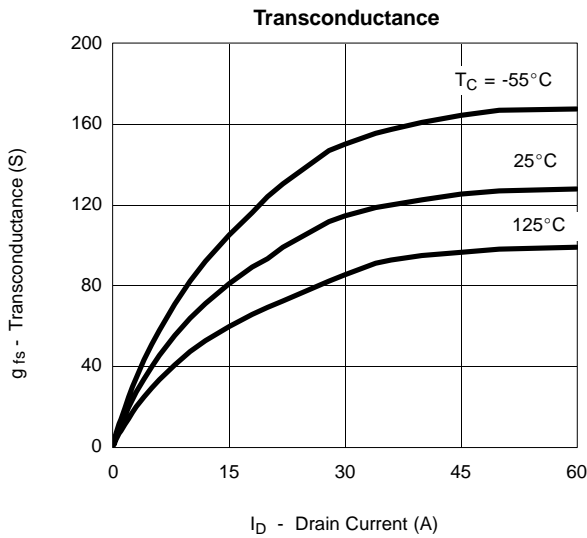
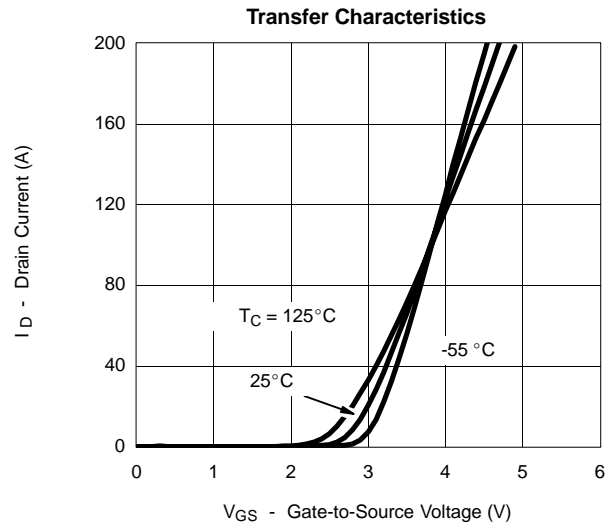
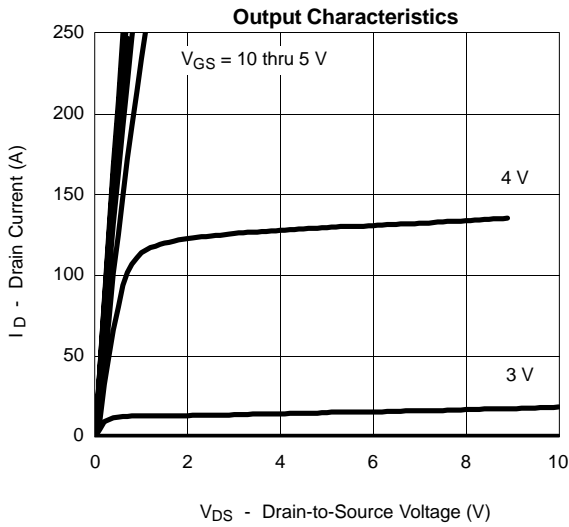
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.
- b. Independent of operating temperature.
- c. Guaranteed by design, not subject to production testing.



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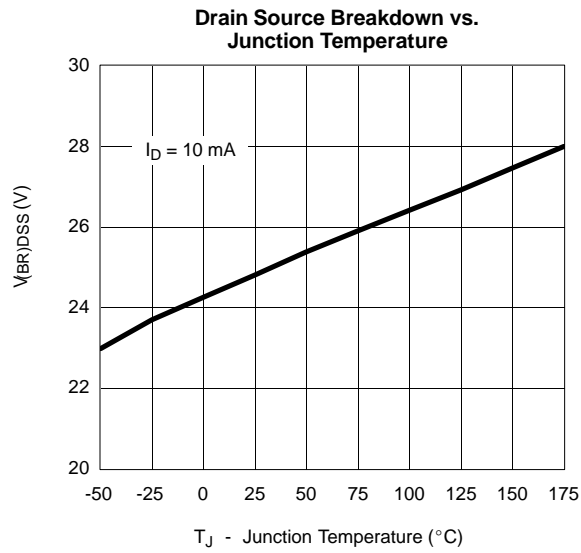
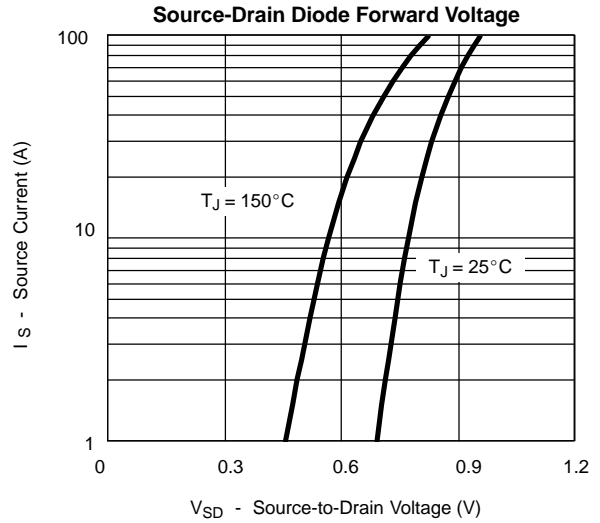
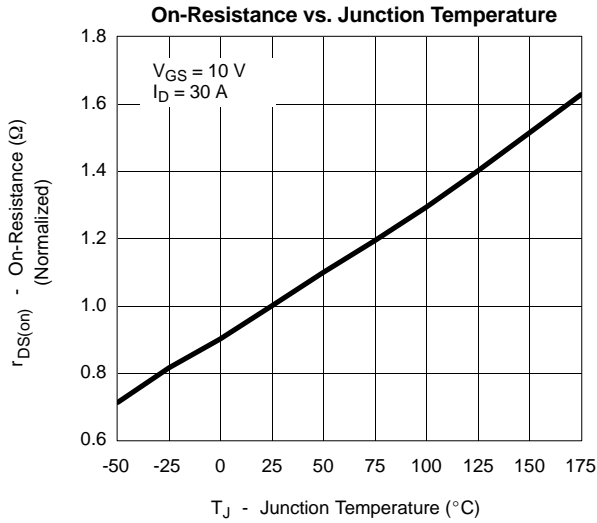
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TYPICAL CHARACTERISTICS (25 °C UNLESS NOTED)





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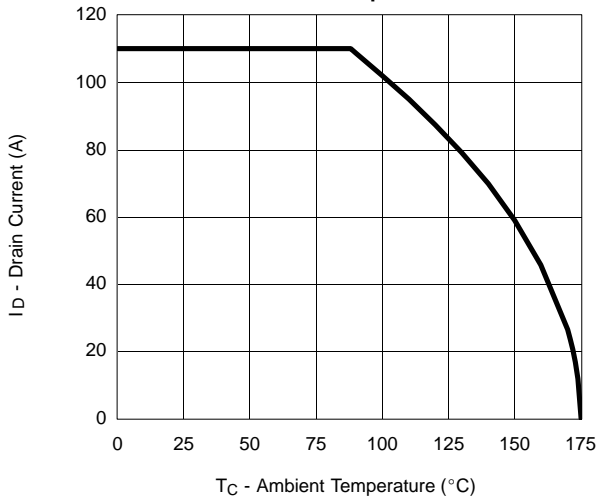


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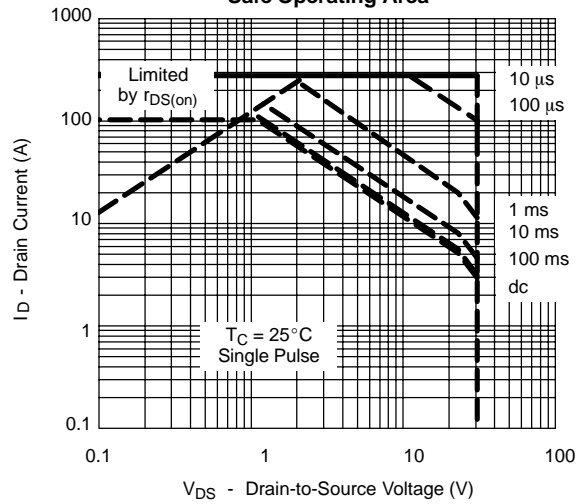
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THERMAL RATINGS

Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

